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Product Change Notice (PCN)

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September 8, 2026

PCN EIC-1178 Additional Wafer Test Location

Detailed Description of Change

Littelfuse IXYS Integrated Circuits Division (ICD) hereby notifies customers of an additional wafer probing location for selected products.

Wafer probe testing for IXD604WW will be expanded to include a qualified outsourced semiconductor assembly and test (OSAT) partner located in Taiwan. This addition is part of Littelfuse's ongoing efforts to optimize manufacturing operations and ensure long-term supply continuity. This OSAT and Beverly will serve as approved wafer probe testing locations.

This change does not affect the product's form, fit, function, quality, reliability, or data sheet specifications.

The affected part numbers are listed below.

Affected Part Number(s)
IXD604WW

Form, fit, function changes: None

Part number changes: None

Effective date: November 30, 2026

Replacement products: N/A

Last time buy: N/A

The PCN number assigned to this action is **PCN EIC-1178** and must be referenced in any correspondence related to the change.

If you have any other questions or concerns, please contact your local Littelfuse sales representative or Product Manager below for further assistance.

Product Management
Power IC